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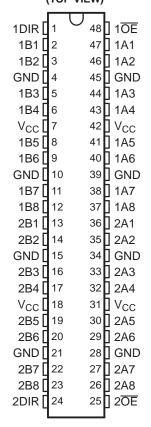
SN54LVT162245A, SN74LVT162245A 3.3-V ABT 16-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS714D-FEBRUARY 2000-REVISED NOVEMBER 2006

FEATURES

- Members of the Texas Instruments Widebus™ Family
- A-Port Outputs Have Equivalent 22- Ω Series Resistors, So No External Resistors Are Required
- Supprt Mixed-Mode Signal Operation (5-V Input and Output Voltages With 3.3-V V_{CC})
- Support Unregulated Battery Operation Down to 2.7 V
- Typical V_{OLP} (Output Ground Bounce)
 <0.8 V at V_{CC} = 3.3 V, T_A = 25°C
- I_{off} and Power-Up 3-State Support Hot Insertion
- Distributed V_{CC} and GND Pins Minimize High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

SN54LVT162245A... WD PACKAGE SN74LVT162245A... DGG OR DL PACKAGE (TOP VIEW)



DESCRIPTION/ORDERING INFORMATION

The 'LVT162245A devices are 16-bit (dual-octal) noninverting 3-state transceivers designed for low-voltage (3.3-V) V_{CC} operation, but with the capability to provide a TTL interface to a 5-V system environment.

These devices are designed for asynchronous communication between two data buses. The logic levels of the direction-control (DIR) input and the output-enable (\overline{OE}) input activate either the B-port outputs or the A-port outputs or place both output ports into the high-impedance mode. The device transmits data from the A bus to the B bus when the B-port outputs are activated, and from the B bus to the A bus when the A-port outputs are activated. The input circuitry on both A and B ports is always active and must have a logic HIGH or LOW level applied to prevent excess I_{CC} and I_{CCZ} .

The A-port outputs, which are designed to source or sink up to 12 mA, include equivalent 22- Ω series resistors to reduce overshoot and undershoot.

When V_{CC} is between 0 and 1.5 V, the devices are in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 1.5 V, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

These devices are fully specified for hot-insertion applications using I_{off} and power-up 3-state. The I_{off} circuitry disables the outputs, preventing damaging current backflow through the devices when they are powered down. The power-up 3-state circuitry places the outputs in the high-impedance state during power up and power down, which prevents driver conflict.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

Widebus is a trademark of Texas Instruments.

SN54LVT162245A, SN74LVT162245A 3.3-V ABT 16-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

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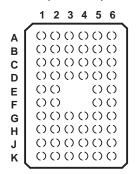


ORDERING INFORMATION

T _A	PACKAG	iE ⁽¹⁾	ORDERABLE PART NUMBER	TOP-SIDE MARKING
	FBGA – GRD	Reel of 1000	SN74LVT162245AGRDR	LZ245A
	FBGA – ZRD (Pb-free)	Reel of 1000	SN74LVT162245AZRDR	LZ245A
		Tubo of 25	SN74LVT162245ADL	
	SSOP - DL	Tube of 25	SN74LVT162245ADLG4	LVT162245A
−40°C to 85°C	330P - DL	Reel of 1000	SN74LVT162245ADLR	LV1162245A
-40°C 10 85°C		Reel of 1000	74LVT162245ADLRG4	
	TSSOP – DGG	Reel of 2000	SN74LVT162245ADGGR	LVT162245A
	1550P – DGG	Reel of 2000	74LVT162245ADGGRE4	LV1162245A
	VFBGA – GQL	Dool of 1000	SN74LVT162245AGQLR	1.7045
	VFBGA – ZQL (Pb-free)	Reel of 1000	SN74LVT162245AZQLR	LZ245A
–55°C to 125°C	CFP – WD	Tube	SNJ54LVT162245AWD ⁽²⁾	SNJ54LVT162245AWD

- (1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.
- (2) Product preview

GQL OR ZQL PACKAGE (TOP VIEW)

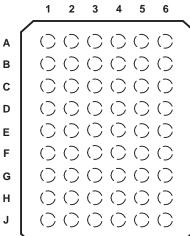


TERMINAL ASSIGNMENTS⁽¹⁾ (56-Ball GQL/ZQL Package)

	1	2	3	4	5	6
Α	1DIR	NC	NC	NC	NC	1 OE
В	1B2	1B1	GND	GND	1A1	1A2
С	1B4	1B3	V _{CC}	V _{CC}	1A3	1A4
D	1B6	1B5	GND	GND	1A5	1A6
E	1B8	1B7			1A7	1A8
F	2B1	2B2			2A2	2A1
G	2B3	2B4	GND	GND	2A4	2A3
Н	2B5	2B6	V _{CC}	V _{CC}	2A6	2A5
J	2B7	2B8	GND	GND	2A8	2A7
K	2DIR	NC	NC	NC	NC	2 OE

(1) NC - No internal connection

GRD OR ZRD PACKAGE (TOP VIEW)



TERMINAL ASSIGNMENTS⁽¹⁾ (54-Ball GRD/ZRD Package)

	1	2	3	4	5	6
Α	1B1	NC	1DIR	1 OE	NC	1A1
В	1B3	1B2	NC	NC	1A2	1A3
С	1B5	1B4	V _{CC}	V _{CC}	1A4	1A5
D	1B7	1B6	GND	GND	1A6	1A7
E	2B1	1B8	GND	GND	1A8	2A1
F	2B3	2B2	GND	GND	2A2	2A3
G	2B5	2B4	V _{CC}	V _{CC}	2A4	2A5
Н	2B7	2B6	NC	NC	2A6	2A7
J	2B8	NC	2DIR	2 OE	NC	2A8

(1) NC - No internal connection

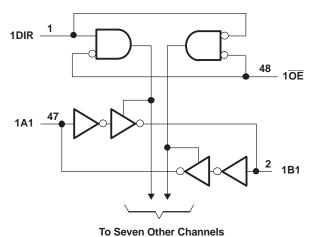


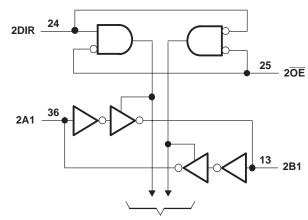
FUNCTION TABLE⁽¹⁾ (EACH 8-BIT SECTION)

CONTRO	L INPUTS	OUTPUT C	IRCUITS	OPERATION
ŌĒ	DIR	A PORT	B PORT	OPERATION
L	L	Enabled	Hi-Z	B data to A bus
L	Н	Hi-Z	Enabled	A data to B bus
Н	Χ	Hi-Z	Hi-Z Isolation	

(1) Input circuits of the data I/Os always are active.

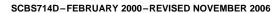
LOGIC DIAGRAM (POSITIVE LOGIC)





To Seven Other Channels

SN54LVT162245A, SN74LVT162245A 3.3-V ABT 16-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS





Absolute Maximum Ratings (1)

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT	
V_{CC}	Supply voltage range		-0.5	4.6	V	
V_{I}	Input voltage range (2)					
V_{O}	Voltage range applied to any output in the high-imp	-0.5	7	V		
V_{O}	Voltage range applied to any output in the high sta	-0.5	$V_{CC} + 0.5$	V		
		SN54LVT162245A (B port)		96		
I_{O}	Current into any output in the low state	SN74LVT162245A (B port)		128	mA	
		A port		30		
		SN54LVT162245A (B port)		48		
Io	Current into any output in the high state (3)	SN74LVT162245A (B port)		64	mA	
		A port		30		
I_{IK}	Input clamp current	V ₁ < 0		-50	mA	
I_{OK}	Output clamp current	V _O < 0		-50	mA	
		DGG package		70		
Δ	Package thermal impedance (4)	DL package		63	°C/W	
θ_{JA}	rackage thermal impedance (9	GQL/ZQL package		42	C/VV	
		GRD/ZRD package		36		
T_{stg}	Storage temperature range		-65	150	°C	

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

Recommended Operating Conditions⁽¹⁾

			SN54LVT162	245A ⁽²⁾	SN74LVT1	62245A	LINUT
			MIN MAX		MIN	MAX	UNIT
V _{CC}	Supply voltage		2.7	3.6	2.7	3.6	V
V _{IH}	High-level input voltage		2		2		V
V _{IL}	Low-level input voltage			0.8		0.8	V
VI	Input voltage			5.5		5.5	V
	High level output ourrent	A port		-12		-12	A
I _{OH}	High-level output current	B port		-24		-32	mA
	Laurianal antoni anno at	A port		12		12	A
I _{OL}	Low-level output current	B port		48		64	mA
Δt/Δν	Input transition rise or fall rate	Outputs enabled		10		10	ns/V
$\Delta t/\Delta V_{CC}$	Power-up ramp rate		200		200		μs/V
T _A	Operating free-air temperature		-55	125	-40	85	°C

⁽¹⁾ All unused or driven (floating) data inputs (I/Os) of the device must be held at logic HIGH or LOW (preferably V_{CCI} or GND) to ensure proper device operation and minimize power. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

 ⁽³⁾ This current flows only when the output is in the high state and V_O > V_{CC}.
 (4) The package thermal impedance is calculated in accordance with JESD 51-7.

⁽²⁾ Product preview



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Electrical Characteristics

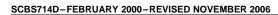
over recommended operating free-air temperature range (unless otherwise noted)

DADA	METER	TEST COL	IDITIONS	SN54L\	/T162245 <i>A</i>	A (1)	SN54L	.VT16224	5A	UNIT
PARA	METER	TEST COM	NDITIONS	MIN	TYP ⁽²⁾	MAX	MIN	TYP ⁽²⁾	MAX	UNII
V _{IK}		$V_{CC} = 2.7 \text{ V},$	I _I = -18 mA			-1.2			-1.2	V
	A nort	$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V},$	$I_{OH} = -100 \ \mu A$	V _{CC} - 0.2			V _{CC} - 0.2			
	A port	$V_{CC} = 3 V$,	I _{OH} = −12 mA	2			2			
V		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V},$	$I_{OH} = -100 \mu A$	V _{CC} - 0.2			V _{CC} - 0.2			V
V_{OH}	Dt	$V_{CC} = 2.7 \text{ V},$	$I_{OH} = -8 \text{ mA}$	2.4			2.4			V
	B port (1) (2) (1)		$I_{OH} = -24 \text{ mA}$	2						
		V _{CC} = 3 V	$I_{OH} = -32 \text{ mA}$				2			
	At	$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V},$	I _{OL} = 100 μA			0.2			0.2	
	A port	V _{CC} = 3 V,	I _{OL} = 12 mA			0.8			0.8	
		V 07.V	I _{OL} = 100 μA			0.2			0.2	
.,		V _{CC} = 2.7 V	I _{OL} = 24 mA			0.5			0.5	
V_{OL}	Dt		I _{OL} = 16 mA			0.4			0.4	V
	B port	V 2.V	I _{OL} = 32 mA			0.5			0.5	
	V _{CC} = 3 V		I _{OL} = 48 mA			0.55				
			I _{OL} = 64 mA						0.55	
	Control	$V_{CC} = 3.6 \text{ V},$	$V_I = V_{CC}$ or GND			±1			±1	
	inputs	$V_{CC} = 0 \text{ or } 3.6 \text{ V},$	V _I = 5.5 V			10			10	
I			V _I = 5.5 V			20			20	μΑ
	A or B port ⁽³⁾	$V_{CC} = 3.6 \text{ V}$	$V_I = V_{CC}$			5			5	
	Port		V _I = 0			-10			-10	
I _{off}		$V_{CC} = 0$,	V_I or $V_O = 0$ to 4.5 V						±100	μΑ
I _{OZPU}		$\frac{V_{CC}}{OE}$ = 0 to 1.5 V, V_{O} = 0	0.5 V to 3 V,			±100 ⁽⁴⁾			±100	μΑ
I _{OZPD}		$\frac{V_{CC}}{OE}$ = 1.5 to 0 V, V_{O} = $\frac{V_{CC}}{OE}$ = don't care	0.5 V to 3 V,			±100 ⁽⁴⁾			±100	μΑ
		V _{CC} = 3.6 V,	Outputs high			0.19			0.19	
I_{CC}		$I_{\Omega} = 0$,	Outputs low			5			5	mA
		$V_I = V_{CC}$ or GND	Outputs disabled			0.19			0.19	
ΔI _{CC} ⁽⁵⁾		V_{CC} = 3 V to 3.6 V, One input at V_{CC} – 0.6 Other inputs at V_{CC} or 0	V, GND			0.3			0.2	mA
Ci		V _I = 3 V or 0			4			4		pF
C _{io}		$V_0 = 3 \text{ V or } 0$			10			10		pF

⁽¹⁾ Product preview

All typical values are at V_{CC} = 3.3 V, T_A = 25°C.
 Unused pins at V_{CC} or GND
 On products compliant to MIL-PRF-38535, this parameter is not production tested.
 This is the increase in supply current for each input that is at the specified TTL voltage level, rather than V_{CC} or GND.

SN54LVT162245A, **SN74LVT162245A 3.3-V ABT 16-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS**





Switching Characteristics

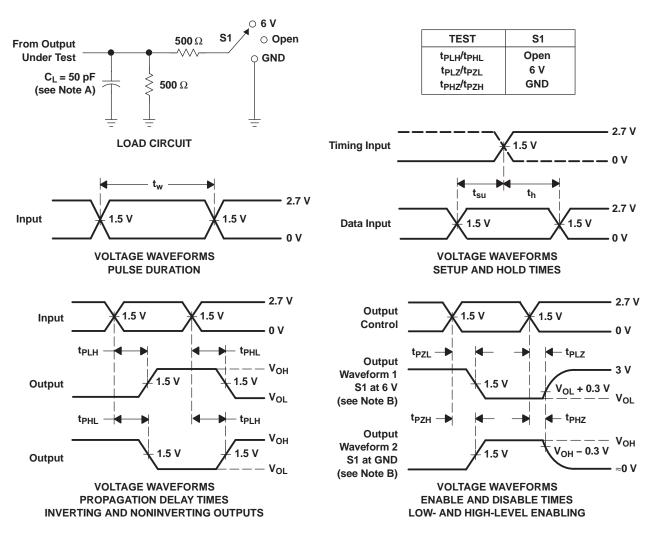
over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

			SN	54LVT10	52245A ⁽¹)		SN74LV	/T1622	45A	
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V_{CC} = 3.3 V \pm 0.3 V		V _{CC} = 2.7 V		V _{C0}	c = 3.3 V 0.3 V	1	V _{CC} = 2.7 V	UNIT
			MIN	MAX	MIN	MAX	MIN	TYP ⁽²⁾	MAX	MIN MAX	
t _{PLH}	Α	В	1	3.5		4	1	2.3	3.3	3.7	ns
t _{PHL}	A	Ь	1	3.5		3.9	1	2.2	3.3	3.5	115
t _{PLH}	В	A	1	4.3		5.3	1	2.8	4	4.6	ns
t _{PHL}	В	^	1	4.2		4.5	1	2.5	3.4	3.6	115
t _{PZH}	ŌĒ	В	1	4.8		5.9	1	2.8	4.6	5.4	ns
t _{PZL}	OE	Ь	1	4.8		5.5	1	3	4.6	5.2	115
t _{PZH}	ŌĒ	A	1	5.5		7.2	1	3.3	5.3	6.3	ns
t _{PZL}	OL	A	1	5.4		6.4	1	3.3	5.1	5.8	115
t _{PHZ}	ŌĒ	В	1.5	5.5		5.8	1.5	3.8	5.2	5.5	ns
t _{PLZ}	OE	Ь	1.5	5.5		5.8	1.5	3.5	5.1	5.4	115
t _{PHZ}	ŌĒ	A	1.5	5.8		6.5	1.5	4	5.6	5.9	ns
t _{PLZ}	OL	A	1.2	6.3		6.3	1.5	3.8	5.5	5.5	115
t _{sk(LH)}									0.5		ns
t _{sk(HL)}									0.5		115

⁽¹⁾ Product preview (2) All typical values are at V_{CC} = 3.3 V, T_A = 25°C.



PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_{O} = 50~\Omega$, $t_{f} \leq$ 2.5 ns, $t_{f} \leq$ 2.5 ns.
- D. The outputs are measured one at a time, with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



PACKAGE OPTION ADDENDUM

24-Aug-2018

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package	Pins	Package	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
SN74LVT162245ADGGR	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	LVT162245A	Samples
SN74LVT162245ADL	ACTIVE	SSOP	DL	48	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	LVT162245A	Samples
SN74LVT162245ADLR	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	LVT162245A	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

24-Aug-2018

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LVT162245ADGGR	TSSOP	DGG	48	2000	330.0	24.4	8.6	13.0	1.8	12.0	24.0	Q1
SN74LVT162245ADLR	SSOP	DL	48	1000	330.0	32.4	11.35	16.2	3.1	16.0	32.0	Q1

www.ti.com 11-Mar-2017



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LVT162245ADGGR	TSSOP	DGG	48	2000	367.0	367.0	45.0
SN74LVT162245ADLR	SSOP	DL	48	1000	367.0	367.0	55.0

DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

DL (R-PDSO-G48)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MO-118

PowerPAD is a trademark of Texas Instruments.



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